

FOR HANDLING
ELECTROSTATIC
SENSITIVE
DEVICES



CAUTION

This bag contains
MOISTURE-SENSITIVE DEVICES If Blank, see adjacent
bar code label

LEVEL
3

1. Calculated shelf life in sealed bag: 12 months at $< 40^{\circ}\text{C}$
and $< 90\%$ relative humidity (RH)
 2. Peak package body temperature: 260 $^{\circ}\text{C}$
If blank, see adjacent bar code label
 3. After bag is opened, devices that will be subjected to reflow
solder or other high temperature process must
 - a) Mounted within: 168 hours of factory
If blank, see adjacent bar code label
conditions $\leq 30^{\circ}\text{C}/60\%$
 - b) Stored at $\leq 10\%$ RH
 4. Devices require bake, before mounting, if:
 - a) Humidity Indicator Card is $> 10\%$ when read at $23 \pm 5^{\circ}\text{C}$
 - b) 3a or 3b not met
 5. If baking is required, devices may be baked for 48 hours at $125 \pm 5^{\circ}\text{C}$
Note: If device containers cannot be subjected to high temperature
or shorter bake times are desired.
reference IPC/JEDEC J-STD-033 for bake procedure
- Bag Seal Date: _____
If blank, see adjacent bar code label
- Note: Level and body temperature defined by IPC/JEDEC J-STD-020



平芯微®
Wuxi PWCHIP Semi Technology CO., LTD

夸克微科技



Product: PW2059

Lot No: 夸克微科技

D/C: 2345

Data:

2023/11/23

QTY: 3000

无锡市平芯微半导体科技有限公司

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